

# 74HC27; 74HCT27

## Triple 3-input NOR gate

Rev. 5.1 — 27 November 2015

Product data sheet

## 1. General description

The 74HC27; 74HCT27 is a triple 3-input NOR gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

## 2. Features and benefits

- Complies with JEDEC standard no. 7A
- Input levels:
  - ◆ For 74HC27: CMOS level
  - ◆ For 74HCT27: TTL level
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

## 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC27D	$-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HCT27D				
74HC27DB	$-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1
74HCT27DB				
74HC27PW	$-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74HCT27PW				
74HC27BQ	$-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1
74HCT27BQ				

nexperia

## 4. Functional diagram

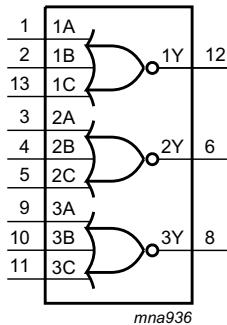


Fig 1. Logic symbol

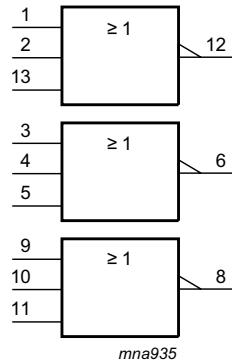


Fig 2. IEC logic symbol

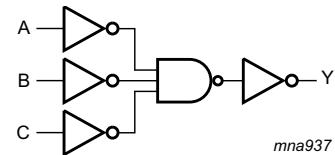


Fig 3. Logic diagram (one gate)

## 5. Pinning information

### 5.1 Pinning

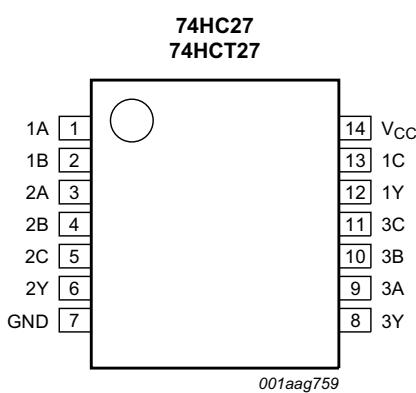
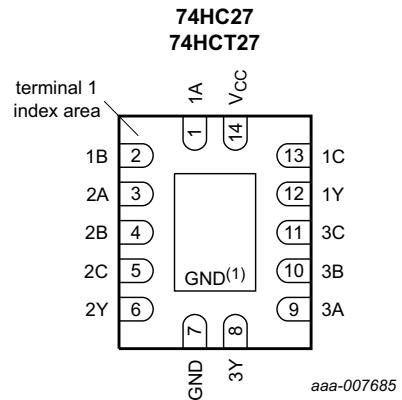


Fig 4. Pin configuration SO14, (T)SSOP14



- (1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.

Fig 5. Pin configuration DHVQFN14

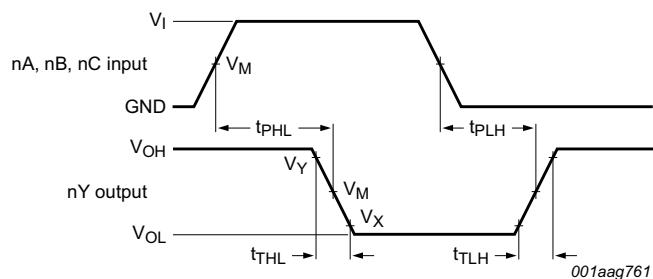








## 11. Waveforms



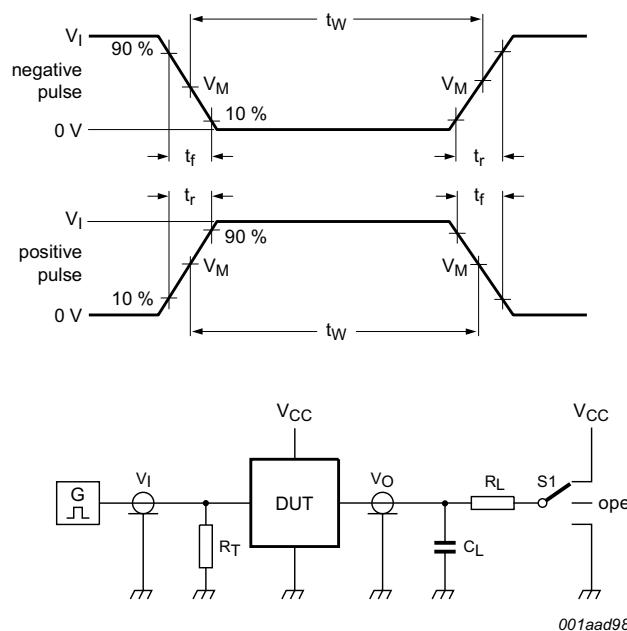
Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

**Fig 6. Input (nA, nB, nC) to output (nY) propagation delays and output transition times**

**Table 8. Measurement points**

<b>Type</b>	<b>Input</b>	<b>Output</b>		
	$V_M$	$V_M$	$V_X$	$V_Y$
74HC27	0.5 $V_{CC}$	0.5 $V_{CC}$	0.1 $V_{CC}$	0.9 $V_{CC}$
74HCT27	1.3 V	1.3 V	0.1 $V_{CC}$	0.9 $V_{CC}$



Test data is given in [Table 9](#).

Definitions test circuit:

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_L$  = Load resistance.

S1 = Test selection switch

**Fig 7. Test circuit for measuring switching times**

**Table 9. Test data**

Type	Input		Load		S1 position
	$V_I$	$t_r, t_f$	$C_L$	$R_L$	
74HC27	Vcc	6 ns	15 pF, 50 pF	1 k $\Omega$	open
74HCT27	3 V	6 ns	15 pF, 50 pF	1 k $\Omega$	open

## 12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

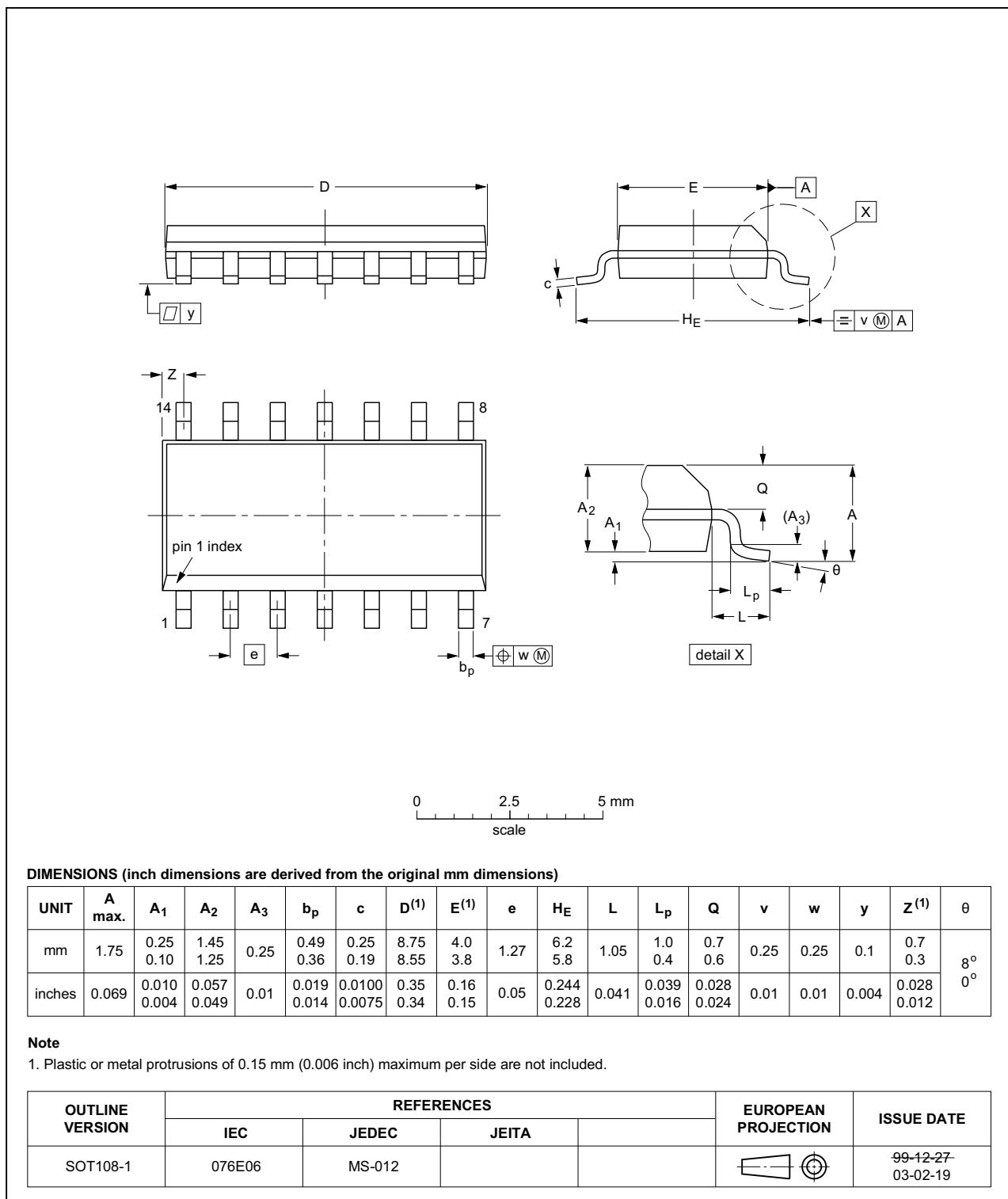


Fig 8. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

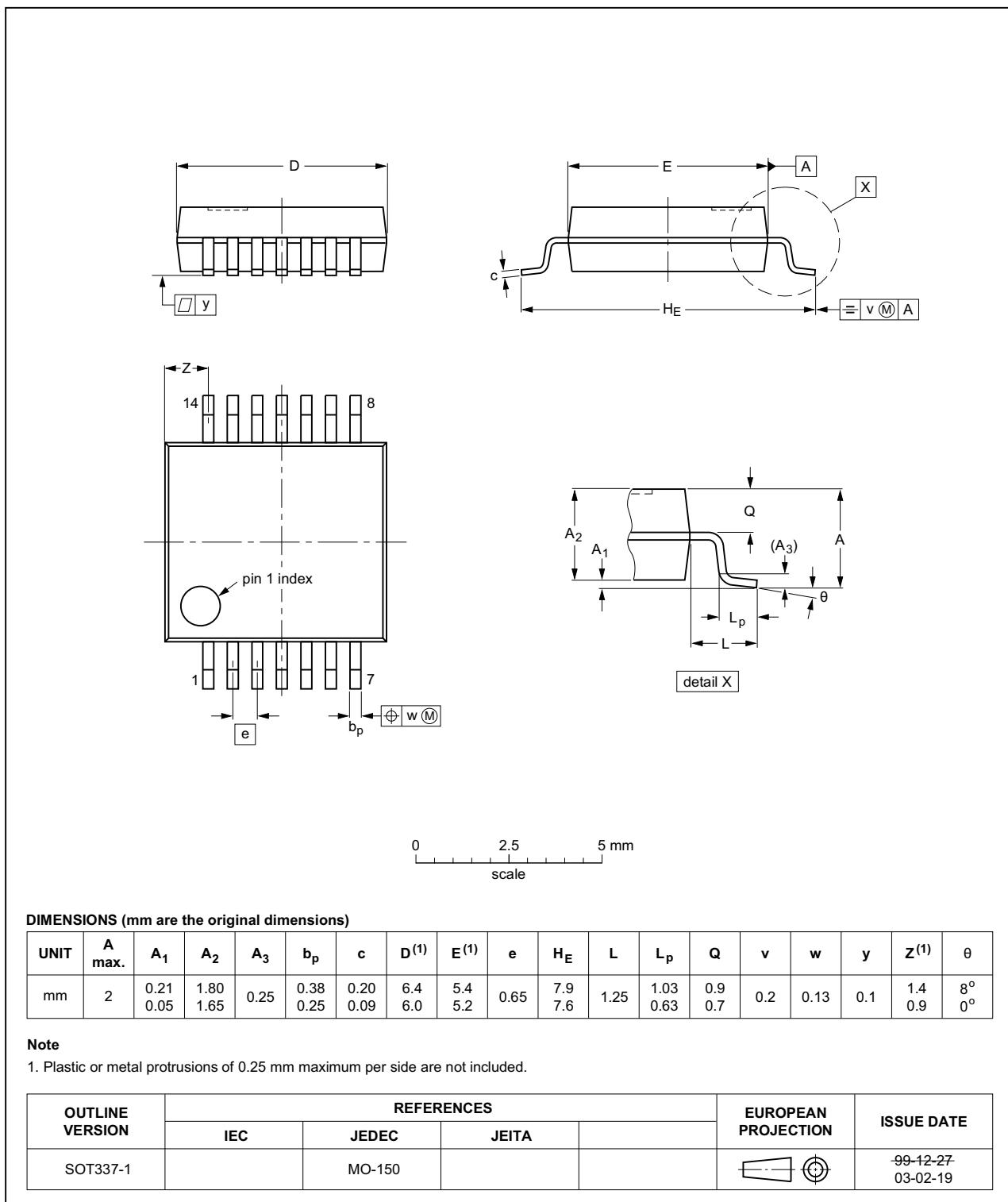


Fig 9. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

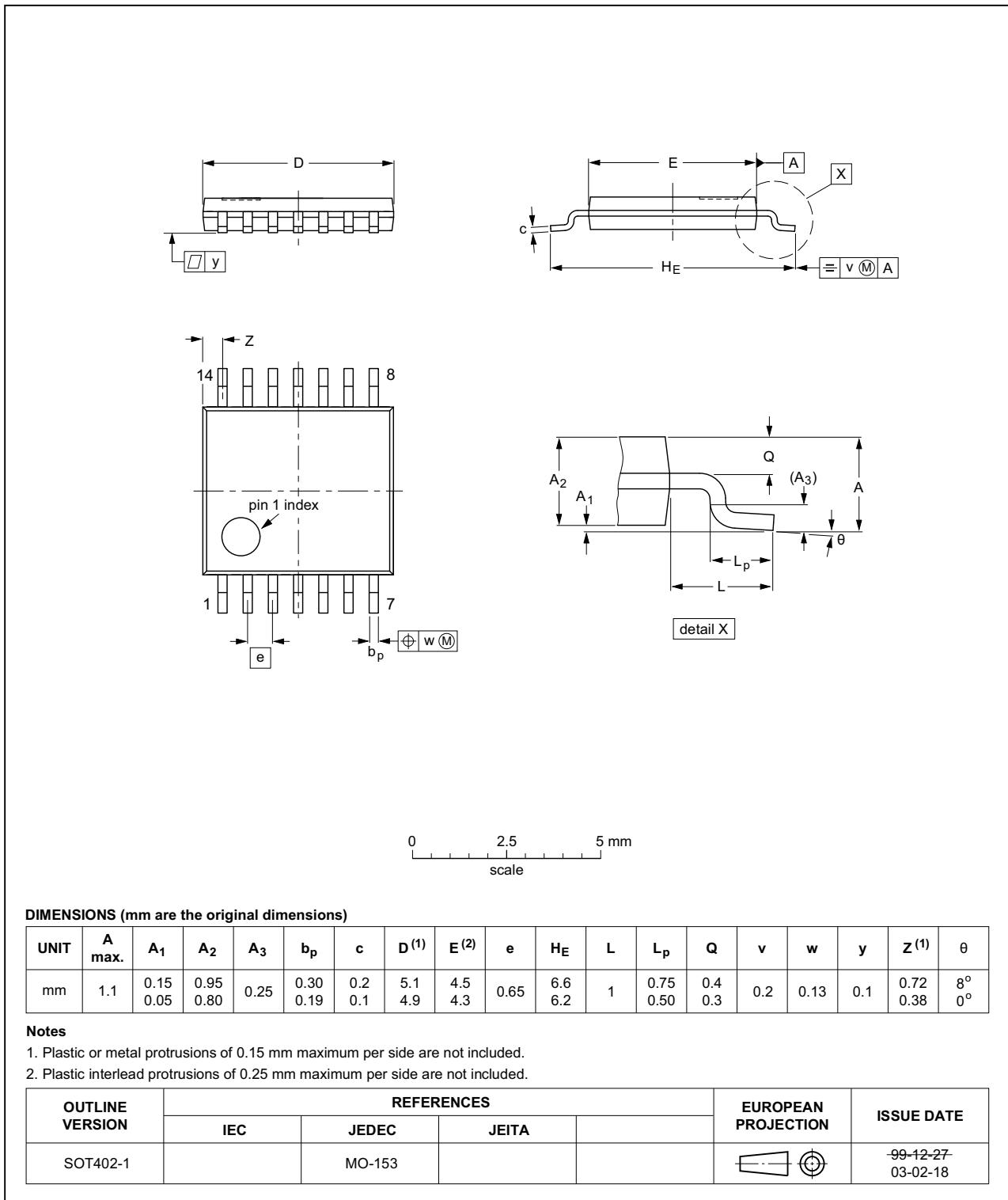


Fig 10. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;  
14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

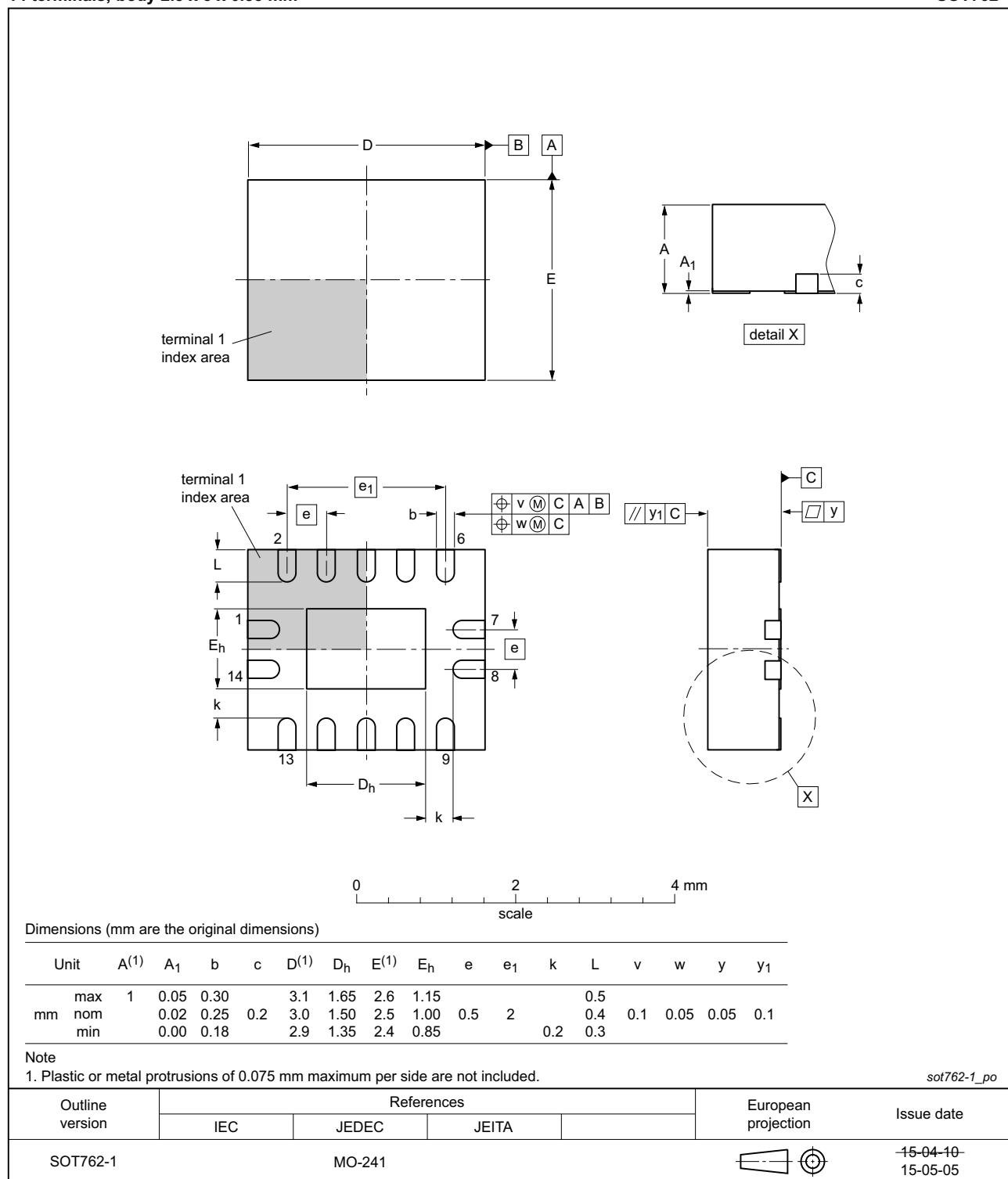


Fig 11. Package outline SOT762-1 (DHVQFN14)

## 13. Abbreviations

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**Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

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**Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT27 v.5.1	20151127	Product data sheet	-	74HC_HCT27 v.5
Modifications:	<ul style="list-style-type: none"> <li>Correction of typo modification date.</li> </ul>			
74HC_HCT27 v.5	20151115	Product data sheet	-	74HC_HCT27 v.4
Modifications:	<ul style="list-style-type: none"> <li>Type numbers 74HC27N and 74HCT27N (SOT27-1) removed.</li> </ul>			
74HC_HCT27 v.4	20130605	Product data sheet	-	74HC_HCT27 v.3
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>			
74HC_HCT27 v.3	20080107	Product data sheet	-	74HC_HCT27_CNV v.2
74HC_HCT27_CNV v.2	19970828	Product specification	-	-



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## 16. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

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